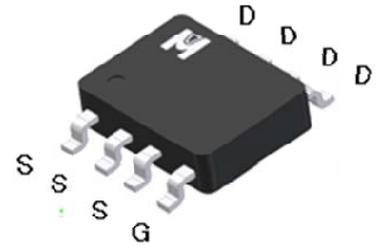
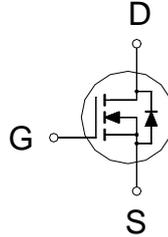


N-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

|                            |      |
|----------------------------|------|
| BV <sub>DSS</sub>          | 30V  |
| R <sub>DS(on)</sub> (MAX.) | 20mΩ |
| I <sub>D</sub>             | 9.5A |



UIS, R<sub>g</sub> 100% Tested

Pb-Free Lead Plating & Halogen Free



ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25 °C Unless Otherwise Noted)

| PARAMETERS/TEST CONDITIONS                     |  | SYMBOL                            | LIMITS     | UNIT |
|--|--|-----------------------------------|------------|------|
| Gate-Source Voltage                            |  | V <sub>GS</sub>                   | ±20        | V    |
| Continuous Drain Current                       | T <sub>A</sub> = 25 °C                             | I <sub>D</sub>                    | 9.5        | A    |
|  | T <sub>A</sub> = 70 °C                             |                                   | 7.5        |      |
| Pulsed Drain Current <sup>1</sup>              |  | I <sub>DM</sub>                   | 38         |      |
| Avalanche Current                              |  | I <sub>AS</sub>                   | 8          |      |
| Avalanche Energy                               | L = 0.1mH, I <sub>D</sub> =8A, R <sub>G</sub> =25Ω | E <sub>AS</sub>                   | 3.2        | mJ   |
| Repetitive Avalanche Energy <sup>2</sup>       | L = 0.05mH   | E <sub>AR</sub>                   | 1.6        |      |
| Power Dissipation                              | T <sub>A</sub> = 25 °C                             | P <sub>D</sub>                    | 2.5        | W    |
|  | T <sub>A</sub> = 70 °C                             |                                   | 1.6        |      |
| Operating Junction & Storage Temperature Range |  | T <sub>j</sub> , T <sub>stg</sub> | -55 to 150 | °C   |

THERMAL RESISTANCE RATINGS

| THERMAL RESISTANCE               | SYMBOL           | TYPICAL | MAXIMUM | UNIT   |
|----------------------------------|------------------|---------|---------|--------|
| Junction-to-Case                 | R <sub>θJC</sub> |         | 25      | °C / W |
| Junction-to-Ambient <sup>3</sup> | R <sub>θJA</sub> |         | 50      |        |

<sup>1</sup>Pulse width limited by maximum junction temperature.

<sup>2</sup>Duty cycle ≤ 1%

<sup>3</sup>50°C / W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.

**ELECTRICAL CHARACTERISTICS (T<sub>c</sub> = 25 °C, Unless Otherwise Noted)**

| PARAMETER   | SYMBOL                                 | TEST CONDITIONS  | LIMITS   |      |      | UNIT |
|---|--|--|--|------|------|------|
|   |  |  | MIN  | TYP  | MAX  |      |
| <b>STATIC</b>   |  |  |  |      |      |      |
| Drain-Source Breakdown Voltage  | V <sub>(BR)DSS</sub>                   | V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA                         | 30   |      |      | V    |
| Gate Threshold Voltage  | V <sub>GS(th)</sub>                    | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA           | 1  | 1.5  | 3    |      |
| Gate-Body Leakage   | I <sub>GSS</sub>                       | V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±20V                         |  |      | ±100 | nA   |
| Zero Gate Voltage Drain Current   | I <sub>DSS</sub>                       | V <sub>DS</sub> = 24V, V <sub>GS</sub> = 0V                          |  |      | 1    | μA   |
|   |  | V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V, T <sub>J</sub> = 125 °C |  |      | 25   |      |
| On-State Drain Current <sup>1</sup>   | I <sub>D(ON)</sub>                     | V <sub>DS</sub> = 10V, V <sub>GS</sub> = 10V                         | 8  |      |      | A    |
| Drain-Source On-State Resistance <sup>1</sup>                                 | R <sub>DS(ON)</sub>                    | V <sub>GS</sub> = 10V, I <sub>D</sub> = 8A                           |  | 15.5 | 20   | mΩ   |
|   |  | V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 6A                          |  | 25   | 30   |      |
| Forward Transconductance <sup>1</sup>   | g <sub>fs</sub>                        | V <sub>DS</sub> = 5V, I <sub>D</sub> = 8A                            |  | 16   |      | S    |
| <b>DYNAMIC</b>  |  |  |  |      |      |      |
| Input Capacitance   | C <sub>iss</sub>                       | V <sub>GS</sub> = 0V, V <sub>DS</sub> = 15V, f = 1MHz                |  | 547  |      | pF   |
| Output Capacitance  | C <sub>oss</sub>                       |  |  | 109  |      |      |
| Reverse Transfer Capacitance  | C <sub>rss</sub>                       |  |  | 83   |      |      |
| Gate Resistance   | R <sub>g</sub>                         | V <sub>GS</sub> = 15mV, V <sub>DS</sub> = 0V, f = 1MHz               |  | 2.0  |      | Ω    |
| Total Gate Charge <sup>1,2</sup>  | Q <sub>g</sub> (V <sub>GS</sub> =10V)  | V <sub>DS</sub> = 15V, V <sub>GS</sub> = 10V,<br>I <sub>D</sub> = 8A |  | 11.5 |      | nC   |
|   | Q <sub>g</sub> (V <sub>GS</sub> =4.5V) |  |  | 6.1  |      |      |
| Gate-Source Charge <sup>1,2</sup>   | Q <sub>gs</sub>                        |  |  | 1.6  |      |      |
| Gate-Drain Charge <sup>1,2</sup>  | Q <sub>gd</sub>                        |  |  | 3.3  |      |      |
| Turn-On Delay Time <sup>1,2</sup>   | t <sub>d(on)</sub>                     |  | V <sub>DS</sub> = 15V,<br>I <sub>D</sub> = 1A, V <sub>GS</sub> = 10V, R <sub>GS</sub> = 6Ω |      | 10   |      |
| Rise Time <sup>1,2</sup>  | t <sub>r</sub>                         |  |  | 12   |      |      |
| Turn-Off Delay Time <sup>1,2</sup>  | t <sub>d(off)</sub>                    |  |  | 15   |      |      |
| Fall Time <sup>1,2</sup>  | t <sub>f</sub>                         |  |  | 10   |      |      |
| <b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T<sub>c</sub> = 25 °C)</b> |  |  |  |      |      |      |
| Continuous Current  | I <sub>S</sub>                         |  |  |      | 2.3  | A    |
| Pulsed Current <sup>3</sup>   | I <sub>SM</sub>                        |  |  |      | 9.2  |      |
| Forward Voltage <sup>1</sup>  | V <sub>SD</sub>                        | I <sub>F</sub> = I <sub>S</sub> , V <sub>GS</sub> = 0V               |  |      | 1.2  | V    |
| Reverse Recovery Time   | t <sub>rr</sub>                        | I <sub>F</sub> = I <sub>S</sub> , dI <sub>F</sub> /dt = 100A / μS    |  | 20   |      | nS   |
| Reverse Recovery Charge   | Q <sub>rr</sub>                        |  |  | 5    |      | nC   |

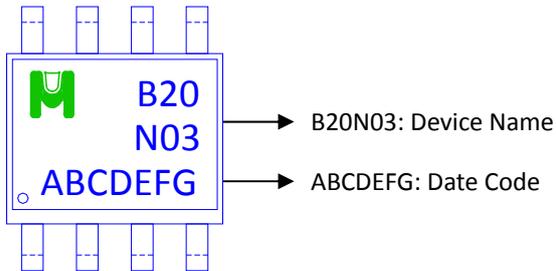
<sup>1</sup>Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

<sup>2</sup>Independent of operating temperature.

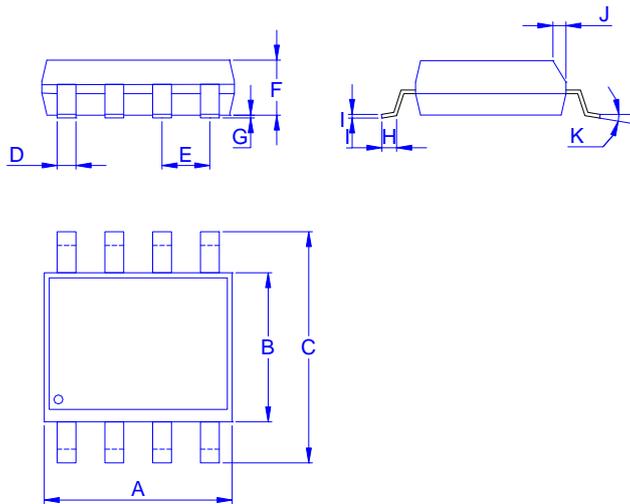
<sup>3</sup>Pulse width limited by maximum junction temperature.

### Ordering & Marking Information:

Device Name: EMB20N03G for SOP-8



### Outline Drawing



Dimension in mm

| Dimension | A    | B    | C    | D    | E    | F    | G    | H    | I    | J    | K  |
|-----------|------|------|------|------|------|------|------|------|------|------|----|
| Min.      | 4.70 | 3.70 | 5.80 | 0.33 |      | 1.20 | 0.08 | 0.40 | 0.19 | 0.25 | 0° |
| Typ.      |      |      |      |      | 1.27 |      |      |      |      |      |    |
| Max.      | 5.10 | 4.10 | 6.20 | 0.51 |      | 1.62 | 0.28 | 0.83 | 0.26 | 0.50 | 8° |

